

1 **DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION**

2 As the below named inventor, I hereby declare that:

3 My residence, post office address and citizenship are as stated
4 below next to my name.

5 I believe I am the original, first and sole inventor of the subject
6 matter which is claimed and for which a patent is sought on the
7 invention entitled: "Chemical-Mechanical Polishing Methods", the
8 specification of which is attached hereto.

9 I hereby state that I have reviewed and understand the contents
10 of the above-identified specification, including the claims.

11 I acknowledge the duty to disclose information known to me to be
12 material to patentability as defined in Title 37, Code of Federal
13 Regulations §1.56.

14 **PRIOR FOREIGN APPLICATIONS:**

15 I hereby state that no applications for foreign patents or inventor's
16 certificates have been filed prior to the date of execution of this
17 declaration.

18 I hereby declare that all statements made herein of my own
19 knowledge are true and that all statements made on information and
20 belief are believed to be true; and further that these statements were
21 made with the knowledge that willful false statements and the like so
22 made are punishable by fine or imprisonment, or both, under

1 Section 1001 of Title 18 of the United States Code and that such willful
2 false statement may jeopardize the validity of the application or any
3 patent issued therefrom.

4 * * * * *

5 Full name of sole inventor: Michael T. Andreas

6 Inventor's Signature: 

7 Date: Dec 28, 1999

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